

**Thin Wafer Market by Wafer Size (125 mm, 200 mm, and 300 mm), Process
(Temporary Bonding & Debonding and Carrier-less/Taiko Process), Technology,
Application (MEMS, CIS, Memory, RF Devices, LED, Interposer, Logic) and Geography
- Global Forecast to 2027**

Market Report | 2022-09-16 | 193 pages | MarketsandMarkets

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